Multispectral CMOS Sensor for LED Color Feedback





Fraunhofer Institute for Integrated Circuits IIS

Am Wolfsmantel 33, 91058 Erlangen, Germany

Dr. Stephan Junger, Nanko Verwaal, Wladimir Tschekalinskij, Dr. Norbert Weber

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Overview

- 1. Introduction: Color sensors for LED monitoring
- Methodology: Color and multispectral sensors in CMOS
- 3. Experimental results: Fabrication and characterization of test chips
- 4. Application:

Detecting the color coordinate (chromaticity point) of a tunable LED luminaire

5. Conclusions



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1. Introduction

Color sensors for LED Monitoring

- LEDs are the ideal light source for many lighting applications due to lifetime, efficiency, and flexible color output
- High-quality illumination devices require precise color matching because of wavelength drift due to temperature change and aging
- Color-sensing feedback achieves better color accuracy than simpler junction-temperature feedback
- LED binning can be reduced
- Cost-effective color and multispectral sensors are needed for high-volume illumination applications



1. Introduction

Technologies for color and multispectral sensors

- Various filter technologies are well established:
 - Absorption filters, e. g. red, green, blue pigmentfilters (Bayer filter)
 - Dielectric filters (thin film filters, interference filters)
 - In spectrometers: prisms, gratings, tunable filters
- Are there other approaches ...
 - Image: feasible using CMOS semiconductor technolgy?
 - In the sensors at low cost?









1. Introduction Nanostructures in art





2. Methodology Nanostructures as spectral filters



Conventional CMOS photodiode

Photodiode with added metal layers as on-chip optical filters



2. Methodology Nanostructures as spectral filters

- Hole arrays with a typical period of 200 400 nm and »enhanced transmission« due to plasmon resonances are used
- Filter wavelength is tailored by varying the geometry





3. Experimental results Test chips with nanostructured filters



Test chip fabricated using an extended CMOS process of X-FAB (Erfurt, Germany)



4. Application Multispectral CMOS sensor with 16 channels



- 16 photodiodes with different filters
- 16 integrated preamplifiers (transimpedance amplifier with switchable gain and offset correction)
- Up to 16 spectral channels
- Chip size approx. 2,5 x 2,5 mm²



4. Application

Detection of the chromaticity point

- Calibration against colorimeter
- Mapping of 12 sensor channels to the CIE tristimulus values X, Y and Z
- Measurement of the xy color coordinate











































































4. Further applications

Spectral estimation and color rendering index

- Spectral estimation of the continuous spectral emission of light sources
- E. g. using 12 sensor channels
 - for the estimation of the spectrum at e.g. 100 wavelengths
 - using side conditions when solving the underdetermined equations
- Once the spectrum is known:
 - Tristimulus values (XYZ)
 - Chromaticity coordinates (xy)
 - Color rendering index (CRI)
 - Color quality scale (CQS)

can be calculated easily



5. Condusions

High-quality LED systems benefit from color feedback sensors

- Photodiodes with on-chip color filters can be fabricated in high volume at low cost using a CMOS process
- Multichannel sensor response can be mapped to CIE tristimulus values X, Y and Z, providing chromaticity xy (CIE 1931)

Outlook:

- Quantification of sensor accuracy (MacAdam ellipses etc.)
- Implementation of LED control to stabilize chromaticity point of the LED luminaire demonstration system
- Algorithms for spectral estimation and measurement of color rendering index (CRI)



Acknowledgements

This work is funded by the German Federal Ministry of Education and Research within the program »ICT 2020 - Research for Innovation«

- Project »COLOR_SPEC« (contract number: 16SV5289)
- Project »FEEDLED« (contract number: 16ES0266)



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Introducing EU project »LASSIE-FP7« Objectives

- Project addresses all the limitations of today's solid-state lighting (SSL) modules
- Improvements in terms of size (area and thickness), flexibility, efficiency, lighting quality, beam-shaping, lifetime, added intelligence production and production/installation costs
- Large-area, roll-to-roll (R2R) processes on thin rigid to flexible plastic substrates
- Hybrid approach combining inorganic LEDs and organic materials
- Alternative to the OLED technology
- Expected outcome: innovative large-area, high-performance, reliable, intelligent, and low-cost LED-based module for professional and architectural lighting (20x20 cm², possible up-scaling to 60x60 cm²)





Introducing EU project »LASSIE-FP7« Building block: Light management solutions

Integration of:

- Light in-coupling, guiding and out-coupling optical micro/nano structures
- Color conversion solutions







Introducing EU project »LASSIE-FP7« Building block: Sensor device

- A sensor device development
- Monolithic integration of the sensor in CMOS technology with color feedback



LFoundry chip



Optical images from MPW



SEM image of nanostructure



Thank you for your attention

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